

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S113	65	("2795770" "2872391" "2969517" "3305416" "3312870" "3317652" "3446908" "3516156" "3519959" "3524960" "3781596" "3821692" "3827004" "3829601" "3875479" "3880486" "3927841" "4181396" "4562301" "4591220" "4591659" "4610756" "4633035" "4663208" "4679122" "4681655" "4691078" "4691971" "4755911" "4784707" "4786523" "4830691" "4906198" "5015207" "5072075" "5097390" "5129142" "5130882" "5183404" "5217478" "5224017" "5236772" "5281771" "5301420" "5348792" "5362359" "5372872" "5487684").PN. OR ("5619018").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 10:28
S114	4	US-4404059-\$.DID. OR US-5738797-\$.DID.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 10:28
S115	37	("3801388" "4404059" "4710419" "4944908" "5220488").PN. OR ("5738797").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 10:29
S116	16	("3801388" "4289846" "4404059" "4561173" "5308440" "5408742" "5738797" "6020215" "6214719" "6217783" "6218282" "6248247" "6265321" "6268262" "6287979" "6297145").PN. OR ("6449839").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 11:21
S117	2	"6449839".pn.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 11:21

S11 8	16	("3801388" "4289846" "4404059" "4561173" "5308440" "5408742" "5738797" "6020215" "6214719" "6217783" "6218282" "6248247" "6265321" "6268262" "6287979" "6297145").PN. OR ("6449839").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 11:21
S11 9	8	("3801388" "4404059" "5148260" "5738797").PN. OR ("6248247").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 13:47
S12 0	2	"6015607".pn.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 14:01
S12 1	5	("6015607").URPN.	USPAT	OR	ON	2005/07/14 13:49
S12 2	10	("3913223" "5306546" "5457881" "5719354" "5737837" "5874784" "6015607" "6118183" "6132226" "6163957").PN. OR ("6717064").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 13:50
S12 3	2	flexible near pcb and heat adj sink and bonding and adhering	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:22
S12 4	2	"6535780".pn.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:07
S12 5	2	"5657426".pn.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:08
S12 6	13	("3372474" "4354895" "4789423").PN. OR ("4969257"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 15:20
S12 7	5	flexible near pcb and heat adj sink and adhering	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:23
S12 8	39	flexible near pcb and heat adj sink	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:27
S12 9	22	flexible near pcb and adhesive and heat near sink	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:27

S13 0	13	("3372474" "4354895" "4789423").PN. OR ("4969257"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 15:32
S13 1	192	pcb and adhesive near layer and heat near sink	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:33

S13 2	106	("20010015492" "20020012762" "4024570" "4059467" "4059708" "4081825" "4143456" "4264917" "4300153" "4323914" "4358552" "4507675" "4602678" "4628406" "4642671" "4801998" "4862245" "4873615" "4931852" "4942140" "4961107" "4984059" "5051275" "5071787" "5081067" "5101465" "5108955" "5120665" "5144747" "5173764" "5175613" "5182173" "5184208" "5194930" "5201866" "5218759" "5227663" "5233220" "5239200" "5249101" "5252853" "5286679" "5289346" "5291064" "5304842" "5311060" "5344795" "5358598" "5358904" "5358906" "5371044" "5378924" "5379186" "5379187" "5379191" "5385869" "5387554" "5394303" "5396403" "5432127" "5432675" "5434105" "5436203" "5438216" "5441684" "5450283" "5455200" "5455457" "5461255" "5468995" "5477082" "5488254" "5489538" "5489801" "5541446" "5552635" "5579573" "5594282" "5596231" "5598034" "5604376" "5610442" "5641997" "5652461" "5656857" "5659952" "5663106" "5672548" "5681757" "5701034" "5705851" "5891753" "5898571" "5905638" "5909056" "5931222" "5969947" "6081027" "6121680" "6190945" "6232152" "6249436" "6251707" "6263566" "6432511" "6534859").PN. OR ("6806567").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/07/14 15:42
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S13 3	1	bond near film and adhesive and laminating near heat near sink	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:45
S13 4	85	bond near film and adhesive and heat near sink	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:45
S13 5	9	bond near film and adhesive and heat near sink and "29"/\$.ccls.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 15:48
S13 6	21	bond near film and adhesive and heat near sink and "156"/\$.ccls.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 16:23
S13 7	1381	welding and connector and fusion	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 16:24
S13 8	186	welding and connector and fusion and "219"/\$.ccls.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/14 16:31
S13 9	20	US-3982808-\$.DID. OR US-4270824-\$.DID. OR US-4278312-\$.DID. OR US-4702539-\$.DID. OR US-5002500-\$.DID. OR US-5051539-\$.DID. OR US-5902150-\$.DID. OR US-6050855-\$.DID. OR US-6193548-\$.DID. OR US-6489554-\$.DID.	USPAT; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/15 07:06